

## Triac (Bidirectional Triode Thyristor)

### Features and Benefits

- Exceptional reliability
- Small fully-molded SIP package with heatsink mounting for high thermal dissipation and long life
- $V_{DRM}$  of 600 V
- 3  $A_{RMS}$  on-state current
- Uniform switching
- UL Recognized Component



Package: 3-pin SIP (TO-220F)



Not to scale

### Description

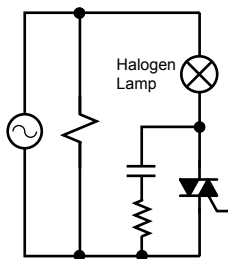
This SanKen triac (bidirectional triode thyristor) is designed for AC power control, providing reliable, uniform switching for full-cycle AC applications.

In comparison with other products on the market, the TMA36H-L provides increased isolation voltage (1800  $V_{AC_{RMS}}$ ), guaranteed for up to 1 minute, and greater peak nonrepetitive off-state voltage,  $V_{DSM}$  (700 V). In addition, commutation  $dv/dt$  and  $(dv/dt)_c$  are improved.

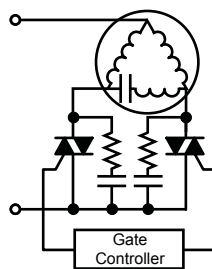
### Applications

- Residential and commercial appliances: vacuum cleaners, rice cookers, TVs, home entertainment
- White goods: washing machines
- Office automation power control, photocopiers
- Motor control for small tools
- Temperature control, light dimmers, electric blankets
- General use switching mode power supplies (SMPS)

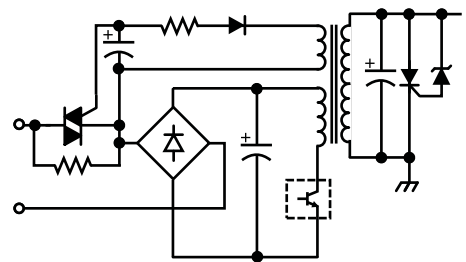
### Typical Applications



Heater control  
(for example, LBP, PPC, MFP)



Two-phase motor control  
(for example, washing machine)



In-rush current control  
(for example, SMPS)

# TMA36H-L

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## Selection Guide

Part Number	Package	Packing
TMA36H-L	3-pin fully molded SIP with heatsink mount	50 pieces per tube

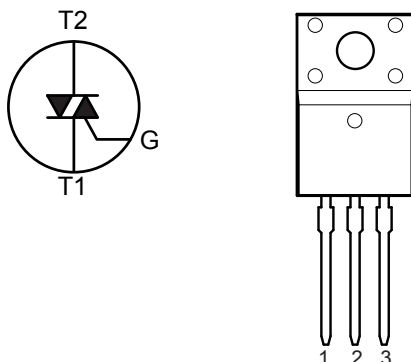
## Absolute Maximum Ratings

Characteristic	Symbol	Notes	Rating	Units	
Peak Repetitive Off-State Voltage	$V_{DRM}$	$R_{GREF} = \infty$	600	V	
Peak Non-Repetitive Off-State Voltage	$V_{DSM}$	$R_{GREF} = \infty$	700	V	
Isolation Voltage	$V_{ISO}$	AC RMS applied for 1 minute between lead and case	1800	V	
RMS On-State Current	$I_{T(RMS)}$	50/60 Hz full cycle sine wave, total Conduction angle $(\alpha+) + (\alpha-) = 360^\circ$ , $T_C = 109^\circ\text{C}$	3	A	
Surge On-State Current	$I_{TSM}$	$f = 60\text{ Hz}$	Full cycle sine wave, peak value, non-repetitive, initial $T_J = 25^\circ\text{C}$	32	A
		$f = 50\text{ Hz}$		30	A
$I^2t$ Value for Fusing	$I^2t$	Value for 50 Hz half cycle sine wave, 1 cycle, $I_{TSM} = 30\text{ A}$	4.5	$\text{A}^2 \cdot \text{s}$	
Critical Rising Rate of On-State Current	$di/dt$	$I_T = I_{T(RMS)} \times \sqrt{2}$ , $V_D = V_{DRM} \times 0.5$ , $f \leq 60\text{ Hz}$ , $t_{gw} \geq 10\ \mu\text{s}$ , $t_{gr} \leq 250\text{ ns}$ , $I_{gp} \geq 60\text{ mA}$ (refer to Gate Trigger Current diagram)	25	$\text{A}/\mu\text{s}$	
Peak Gate Current	$I_{GM}$	$f \geq 50\text{ Hz}$ , duty cycle $\leq 10\%$	0.5	A	
Peak Gate Power Dissipation	$P_{GM}$	$f \geq 50\text{ Hz}$ , duty cycle $\leq 10\%$	3	W	
Average Gate Power Dissipation	$P_{GM(AV)}$		0.3	W	
Junction Temperature	$T_J$		-40 to 125	$^\circ\text{C}$	
Storage Temperature	$T_{stg}$		-40 to 125	$^\circ\text{C}$	

## Thermal Characteristics May require derating at maximum conditions

Characteristic	Symbol	Test Conditions	Value	Units
Package Thermal Resistance (Junction to Case)	$R_{\theta JC}$	For AC	4.6	$^\circ\text{C}/\text{W}$

## Pin-out Diagram



## Terminal List Table

Number	Name	Function
1	T1	Main terminal, gate referenced
2	T2	Main terminal connect to signal side
3	G	Gate control

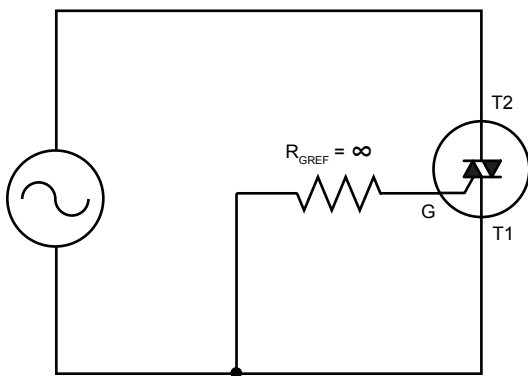
All performance characteristics given are typical values for circuit or system baseline design only and are at the nominal operating voltage and an ambient temperature,  $T_A$ , of  $25^\circ\text{C}$ , unless otherwise stated.

## ELECTRICAL CHARACTERISTICS

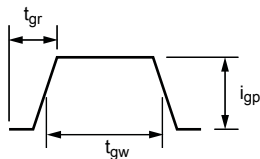
Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Off-State Leakage Current	$I_{DRM}$	$V_D = V_{DRM}, T_J = 125^\circ\text{C}, R_{GREF} = \infty$ using test circuit 1	–	–	2.0	mA
		$V_D = V_{DRM}, T_J = 25^\circ\text{C}, R_{GREF} = \infty$ using test circuit 1	–	–	100	$\mu\text{A}$
On-State Voltage	$V_{TM}$	$I_T = 4.5\text{ A}, T_J = 25^\circ\text{C}$	–	–	1.5	V
Gate Trigger Voltage	$V_{GT}$	Quadrant I: T2+, G+	–	–	1.5	V
		Quadrant II: T2+, G–				
		Quadrant III: T2–, G–				
Gate Trigger Current	$I_{GT}$	Quadrant I: T2+, G+	–	–	20	mA
		Quadrant II: T2+, G–				
		Quadrant III: T2–, G–				
Gate Non-trigger Voltage	$V_{GD}$	$V_D = V_{DRM} \times 0.5, R_L = 4\text{ k}\Omega, T_J = 125^\circ\text{C}$	0.2	–	–	V
Critical Rising Rate of Off-State Voltage during Commutation*	$(dv/dt)_c$	$V_D = 400\text{ V}, (di/dt)_c = -1.5\text{ A/ms}, I_{TP} = 2\text{ A}, T_J = 125^\circ\text{C}$	5	–	–	$\text{V}/\mu\text{s}$
Critical Rising Rate of Off-State Voltage	$dv/dt$	$V_D = V_{DRM} \times 0.66, R_{GREF} = \infty$ using test circuit 1, $T_J = 125^\circ\text{C}$	100	–	–	$\text{V}/\mu\text{s}$

\*Where  $I_{TP}$  is the peak current through T2 to T1.

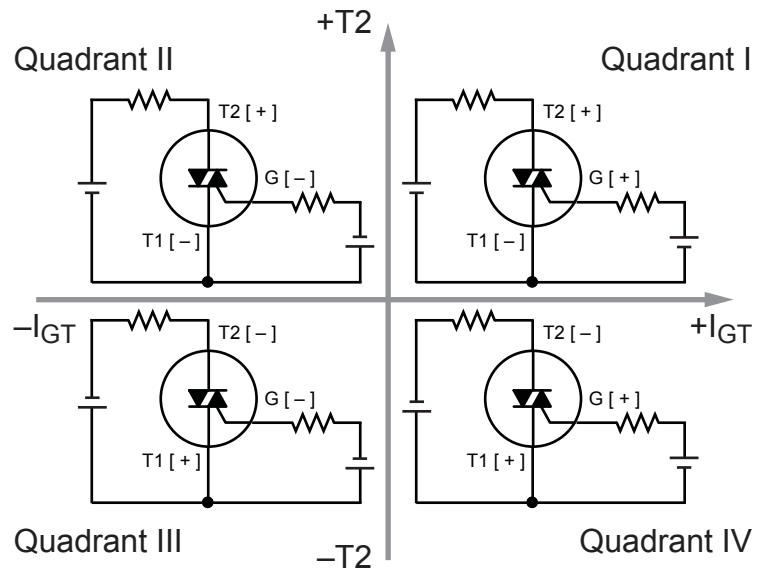
**Test Circuit 1**



**Gate Trigger Current**

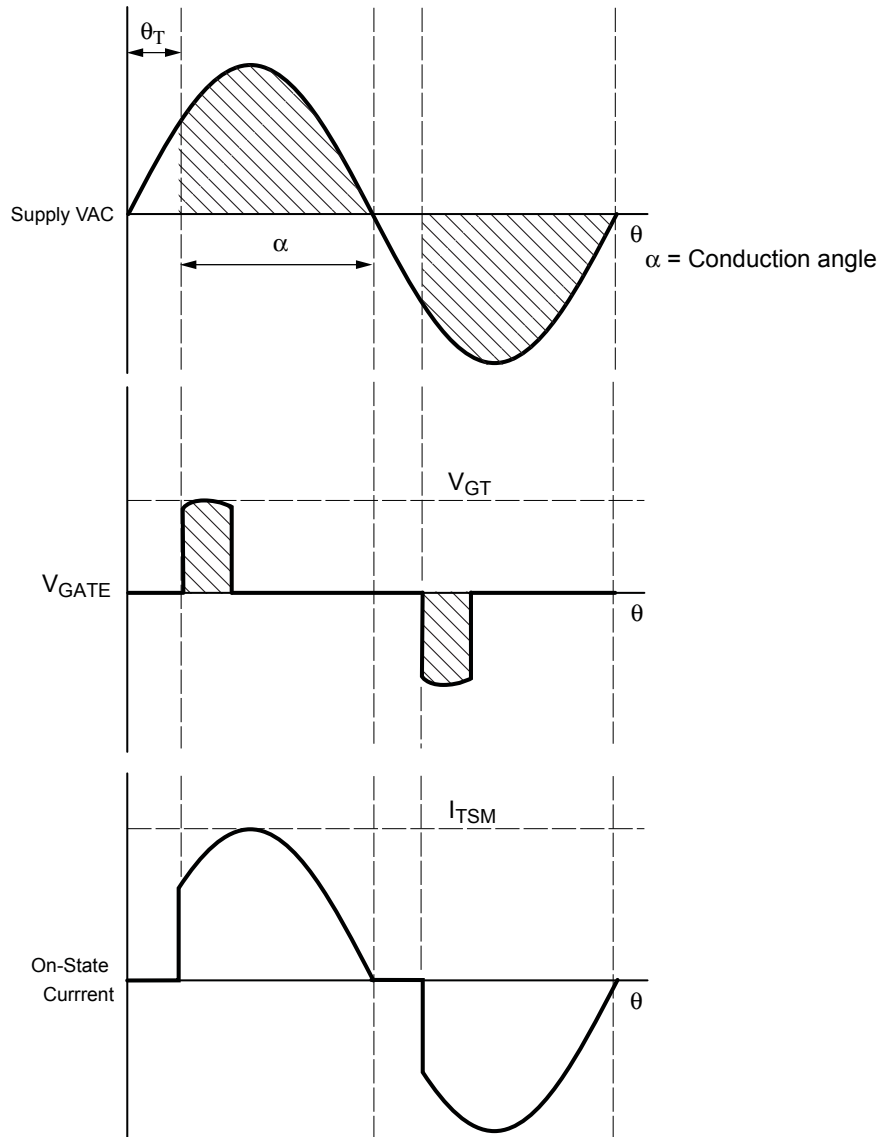


**Gate Trigger Characteristics**

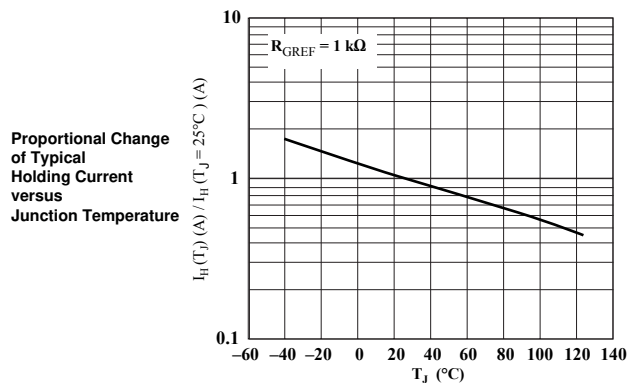
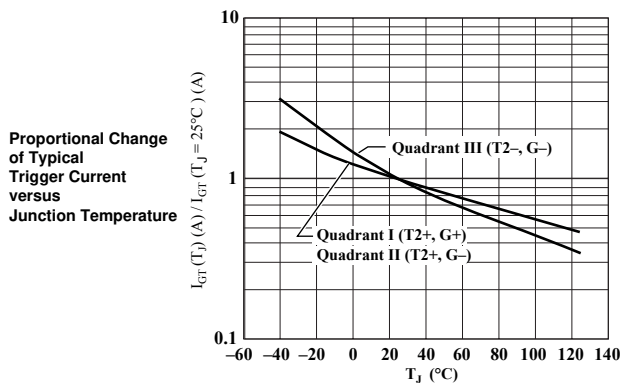
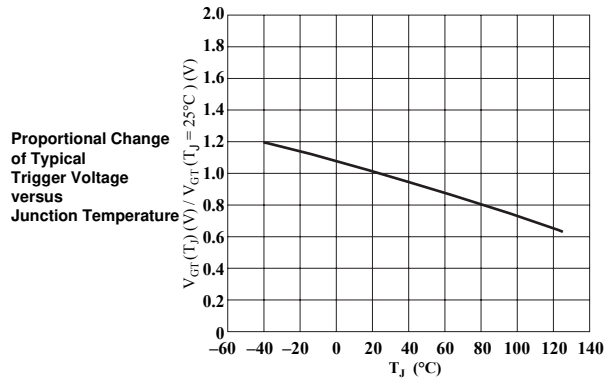
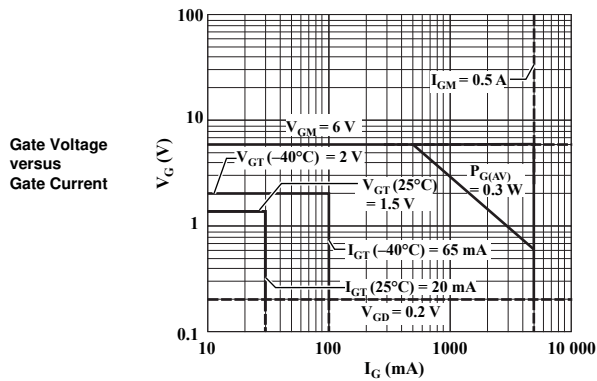
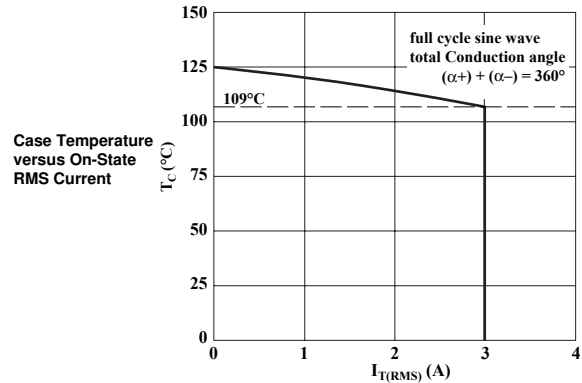
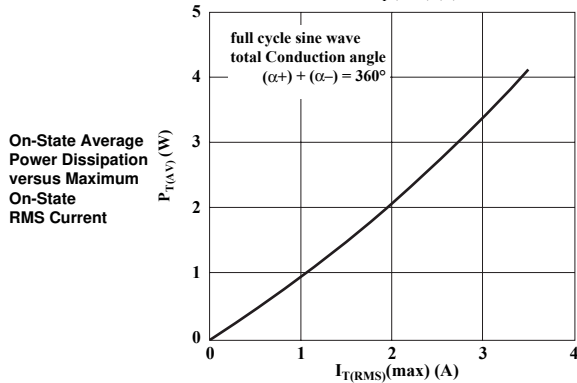
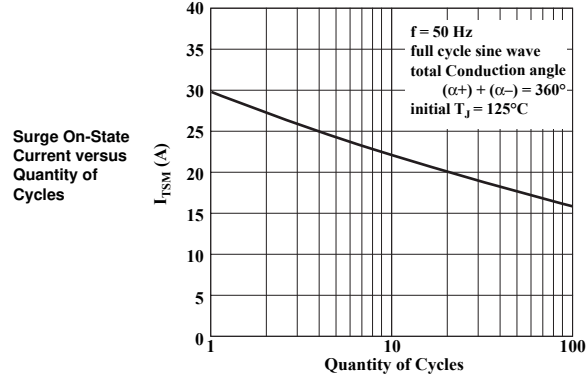
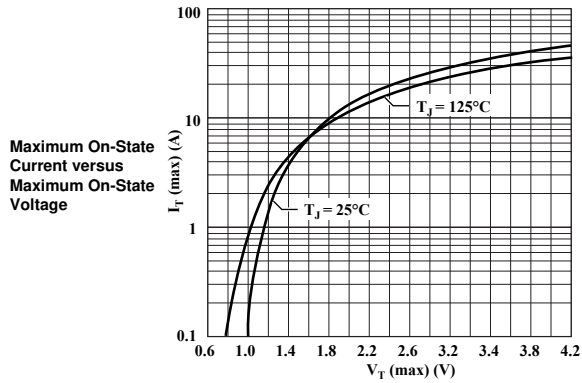


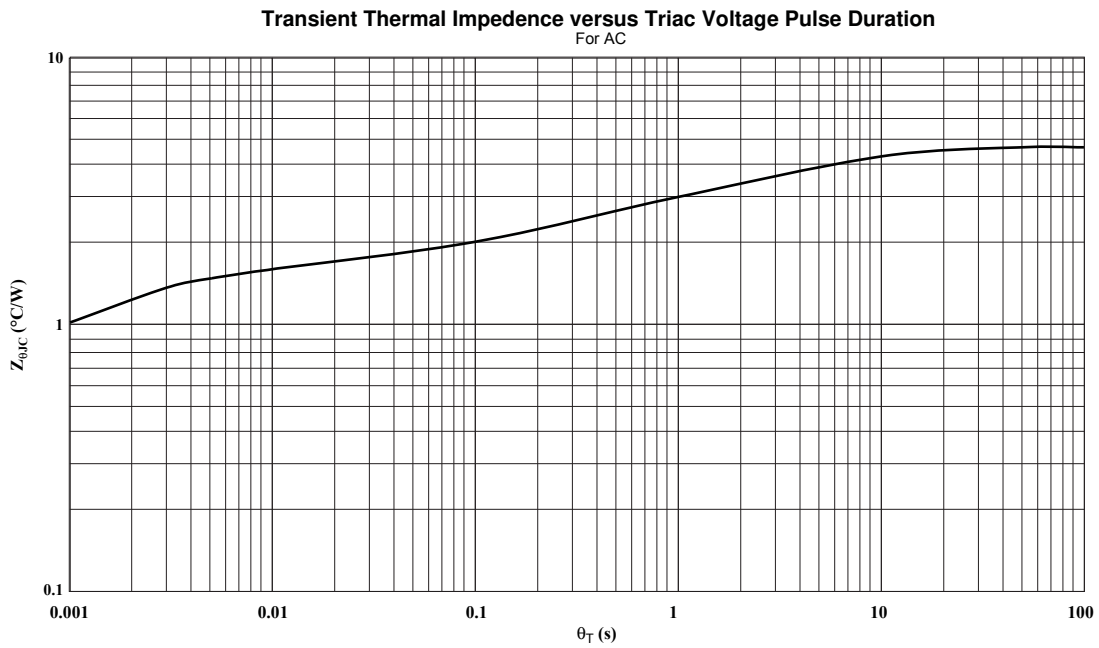
Polarities referenced to T1

Commutation Timing Diagrams



## Performance Characteristics at $T_A = 25^\circ\text{C}$

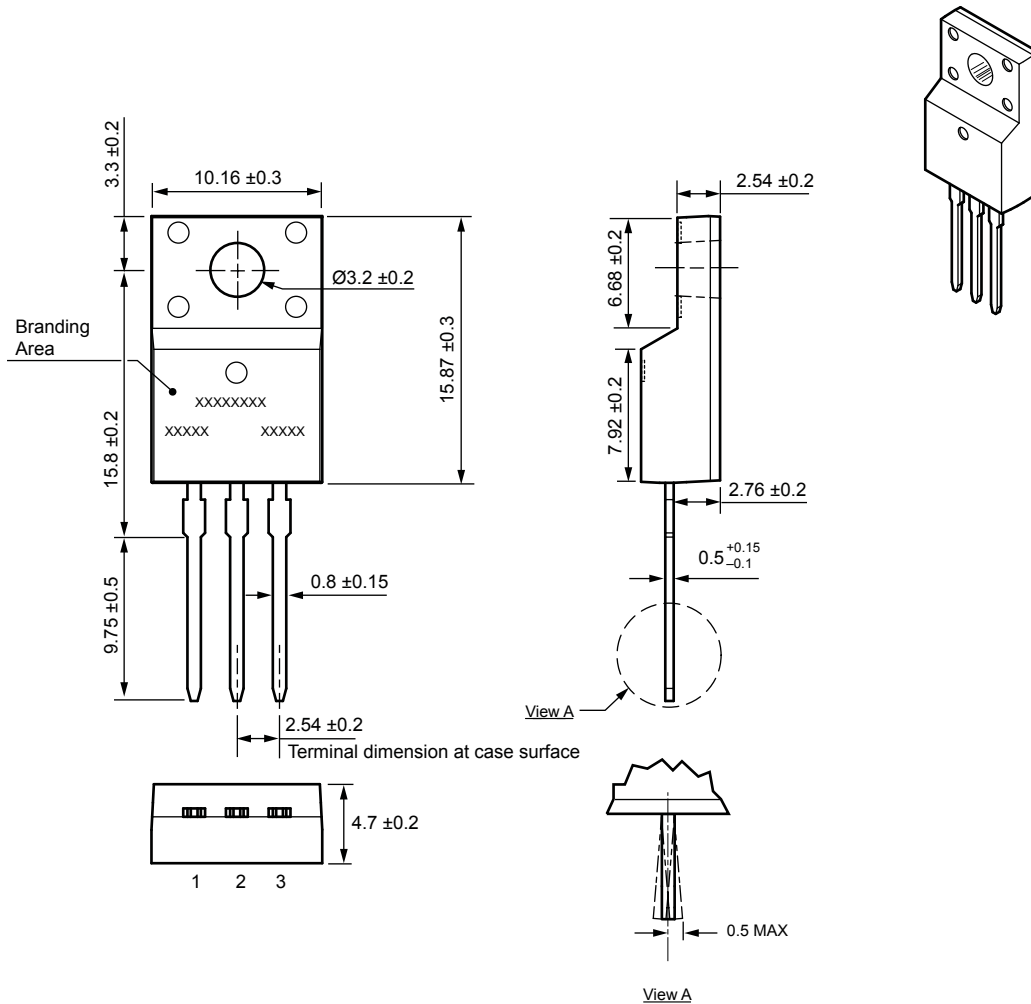




# TMA36H-L

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## TO-220F Package Outline Drawing



Terminal core material: Cu  
Terminal treatment: Sn plating  
Package: TO-220F

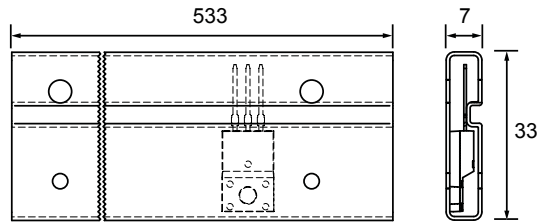
Dimensions in millimeters

Branding codes (exact appearance at manufacturer discretion):  
1st line, type: TMA36H  
2nd line left, lot: YMDDR  
Where: Y is the last digit of the year of manufacture  
M is the month (1 to 9, O, N, D)  
DD is the date  
R is a tracking letter



Leadframe plating Pb-free. Device meets RoHS requirements.

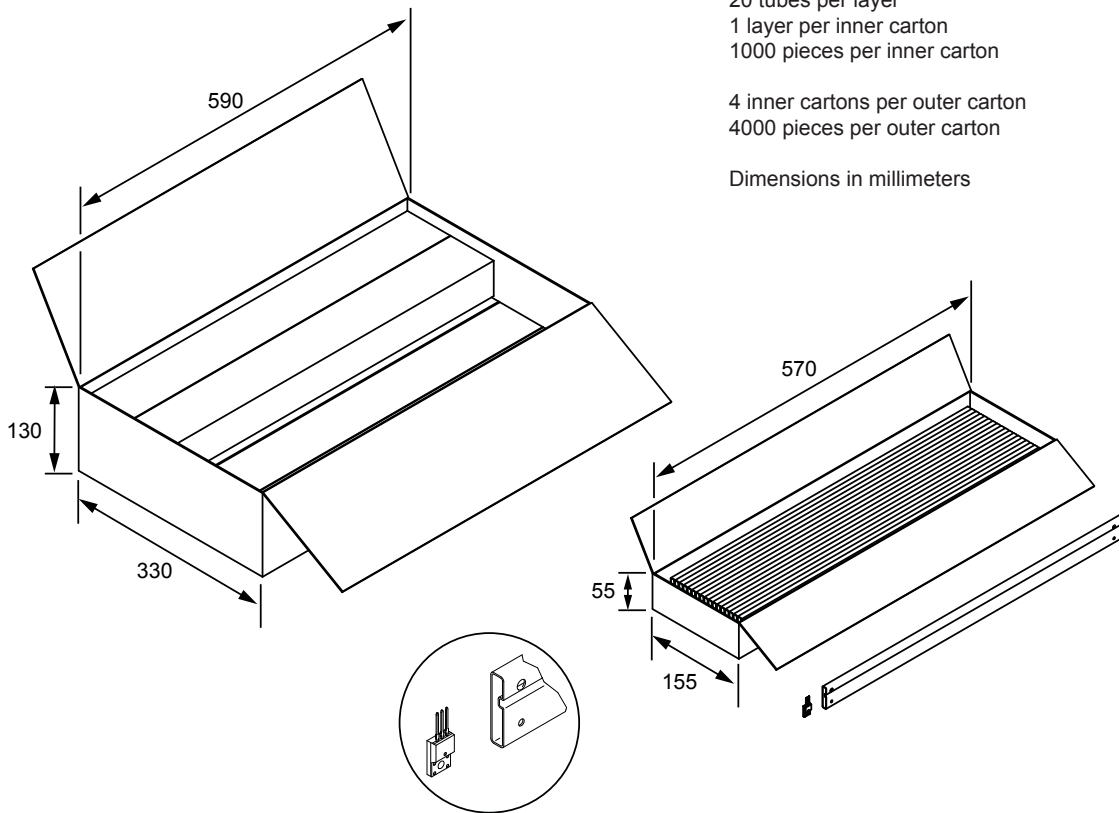
Packing Specification  
Tube Packing



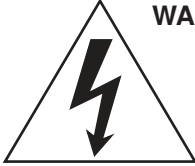
50 pieces per tube  
20 tubes per layer  
1 layer per inner carton  
1000 pieces per inner carton

4 inner cartons per outer carton  
4000 pieces per outer carton

Dimensions in millimeters







**WARNING** — These devices are designed to be operated at lethal voltages and energy levels. Circuit designs that embody these components must conform with applicable safety requirements. Precautions must be taken to prevent accidental contact with power-line potentials. Do not connect grounded test equipment.

The use of an isolation transformer is recommended during circuit development and breadboarding.

Because reliability can be affected adversely by improper storage environments and handling methods, please observe the following cautions.

#### Cautions for Storage

- Ensure that storage conditions comply with the standard temperature (5°C to 35°C) and the standard relative humidity (approximately 40% to 75%); avoid storage locations that experience extreme changes in temperature or humidity.
- Avoid locations where dust or harmful gases are present and avoid direct sunlight.
- Reinspect for rust on leads and solderability of products that have been stored for a long time.

#### Cautions for Testing and Handling

When tests are carried out during inspection testing and other standard test periods, protect the products from power surges from the testing device, shorts between adjacent products, and shorts to the heatsink.

#### Remarks About Using Silicone Grease with a Heatsink

- When silicone grease is used in mounting this product on a heatsink, it shall be applied evenly and thinly. If more silicone grease than required is applied, it may produce stress.
- Coat the back surface of the product and both surfaces of the insulating plate to improve heat transfer between the product and the heatsink.
- Volatile-type silicone greases may permeate the product and produce cracks after long periods of time, resulting in reduced heat radiation effect, and possibly shortening the lifetime of the product.
- Our recommended silicone greases for heat radiation purposes,

which will not cause any adverse effect on the product life, are indicated below:

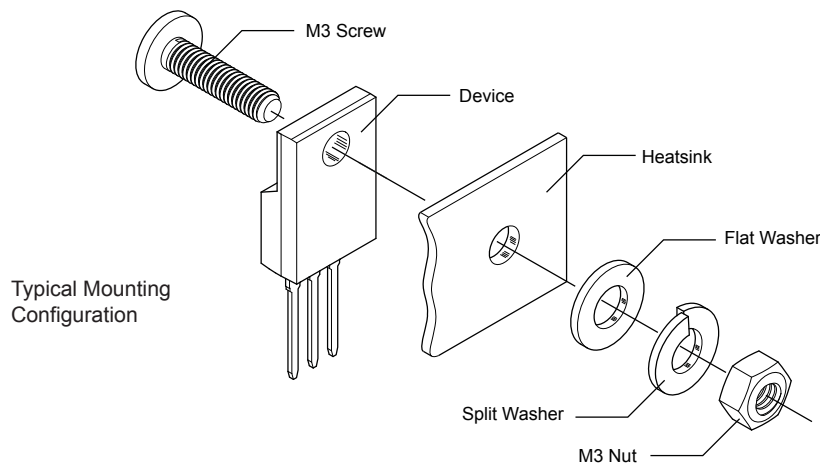
Type	Suppliers
G746	Shin-Etsu Chemical Co., Ltd.
YG6260	Momentive Performance Materials
SC102	Dow Corning Toray Silicone Co., Ltd.

#### Heatsink Mounting Method

- Torque When Tightening Mounting Screws. Thermal resistance increases when tightening torque is low, and radiation effects are decreased. When the torque is too high, the screw can strip, the heatsink can be deformed, and distortion can arise in the product frame. To avoid these problems, observe the recommended tightening torques for this product package type 0.490 to 0.686 N•m (5 to 7 kgf•cm).
- For effective heat transfer, the contact area between the product and the heatsink should be free from burrs and metal fragments, and the heatsink should be flat and large enough to contact over the entire side of the product, including mounting flange and exposed thermal pad.
- The mounting hole in customer-supplied heatsink must be less than Ø4 mm; this includes the diameter of any dimple around punched holes. This is to prevent possible deflection and cracking of the product case when fastened to the heatsink.

#### Soldering

- When soldering the products, please be sure to minimize the working time, within the following limits:  
260°C 10 s  
350°C 3 s
- Soldering iron should be at a distance of at least 1.5 mm from the body of the products



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